Applicant: Craig K. Carlson-Stevermer

Serial No.: 10/622,849 Filed: July 18, 2003 Docket No.: A126.114.102

Title: WAFER STAGING PLATFORM

IN THE CLAIMS

Please amend claims 23 and 24 as follows:

- 1.(Previously Presented) A wafer staging platform for a wafer inspection system comprising:
 - a first vacuum-assisted platform for holding a first wafer;
 - a second vacuum-assisted platform aligned with the first vacuum-assisted platform, the second platform for holding a second wafer;
 - wherein the first and second platforms are in close proximity to a processing platform.

2-4.(Canceled)

- 5.(Previously Presented) A handling system for a wafer inspection system comprising:
 - a wafer processing platform;
 - at least two wafer loadports, each wafer loadport configured to receive a wafer transportation cassette;
 - a wafer staging platform disposed closer to the wafer processing platform than any of the wafer loadports; and
 - a robot configured to move wafers between the wafer processing platform and the wafer staging platform.
 - 6.(Previously Presented) The handling system of claim 5,
 - wherein the robot moves the wafers between one of the at least two wafer loadports and the staging platform.

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7.(Previously Presented) The handling system of claim 5, wherein the wafer transportation cassette is configured for storing a plurality of wafers.

- 8.(Previously Presented) The handling system of claim 5, further comprising:

 a pre-aligner for aligning wafers prior to inspection;

 wherein the robot moves the wafers between the pre-aligner and the wafer staging platform.
- 9.(Previously Presented) The handling system of claim 5, wherein the wafer staging platform comprises at least two platforms, each platform configured for holding a wafer.
- 10.(Previously Presented) The handling system of claim 5, wherein the wafer staging platform comprises a vacuum system for holding at least one wafer in place on the wafer staging platform.
- 11.(Original) The handling system of claim 5, further comprising: a sensor to determine if a wafer is present on the staging platform.
- 12.(Original) The handling system of claim 11, wherein the staging platform comprises the sensor.
- 13.(Original) The handling system of claim 11, wherein the sensor comprises an optical sensor.
- 14.(Original) The handling system of claim 11, wherein the sensor comprises a vacuum sensor.
- 15.(Canceled)

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- 16.(Previously Presented) The method of claim 23, further comprising:

 moving the first sample from the sample holder to the at least one sample loadport.
- 17.(Previously Presented) The method of claim 23, further comprising: providing a pre-aligner; and moving a third sample from the pre-aligner to the sample holder.
- 18.(Previously Presented) The method of claim 16, wherein moving the first sample from the sample holder to the at least one sample loadport occurs while a separate sample is being processed on the sample processing platform.
- 19.(Previously Presented) The method of claim 17, wherein moving the third sample from the pre-aligner to the sample holder occurs while a separate sample is processed on the sample processing platform.
- 20.(Previously Presented) The method of claim 17, wherein moving a third sample includes moving the third sample from the pre-aligner to a second holder in the sample holder.
- 21.(Previously Presented) The method of claim 20, wherein moving the third sample from the pre-aligner to the second holder in the sample holder occurs while a second sample is being processed on the processing platform.
- 22.(Previously Presented) The wafer staging platform of claim 9, wherein the at least two platforms are aligned in a vertical stack.

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23.(Currently Amended) A method for swapping samples in a wafer inspection system that includes at least one sample loadport and a sample processing platform and a robot to move samples between the sample loadport and the sample processing platform, the method comprising:

- i) storing a plurality of samples in the at least one sample loadport;
- ii) removing a first sample from the loadport;
- iii) processing the first sample on the sample processing platform;
- iv) removing the first sample from the sample processing platform;
- v) staging the first sample on a sample holder; and
- vi) returning the first sample to the sample loadport.

24.(Currently Amended) The method of claim 23, further comprising:

staging a second sample in athe sample holder prior to processing the second sample on the sample processing platform.